

## STN3NF06

# N-channel 60V - 0.07Ω -4A - SOT-223 STripFET™ II Power MOSFET

#### **General features**

Туре	V <sub>DSS</sub> (@Tjmax)	R <sub>DS(on)</sub>	I <sub>D</sub>
STN3NF06	60V	<0.1Ω	4A

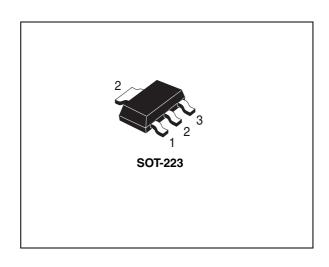
- Exceptional dv/dt capability
- 100% avalanche tested
- Avalanche rugged technology

## **Description**

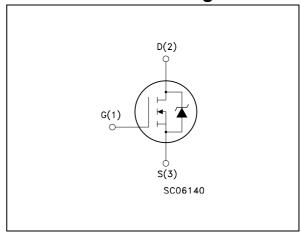
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size<sup>TM</sup>" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

## **Applications**

■ Switching application



#### Internal schematic diagram



#### **Order codes**

Part number	Marking	Package	Packaging
STN3NF06	N3NF06	SOT-223	Tape & reel

Contents STN3NF06

# **Contents**

1	Electrical ratings	. 3
2	Electrical characteristics	. 4
	2.1 Electrical characteristics (curves)	. 6
3	Test circuit	. 8
4	Package mechanical data	. 9
5	Revision history	11

STN3NF06 Electrical ratings

# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	60	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25°C	4	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> =100°C	2.9	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	16	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	3.3	W
	Derating factor	0.026	W/°C
dv/dt (2)	Peak diode recovery voltage slope	10	V/ns
E <sub>AS</sub> (3)	Single pulse avalanche energy	200	mJ
T <sub>J</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 150	°C

<sup>1.</sup> Pulse width limited by safe operating area

Table 2. Thermal data

Rt	hj-pcb	Thermal resistance junction-PCB <sup>(1)</sup> max	38	°C/W
Rt	hj-pcb	Thermal resistance junction-PCB <sup>(2)</sup> max	100	°C/W
	1,(~)	Maximum lead temperature for soldering purpose typ	260	°C

<sup>1.</sup> When Mounted on FR-4 board with 1 inch<sup>2</sup> pad, 2 oz. of Cu. and t < 10 sec.

<sup>2.</sup>  $I_{SD} \leq 4 \text{ A}, \text{ di/dt} \leq 150 \text{A/}\mu\text{s}, V_{DD} \leq V_{(BR)DSS}, T_J \leq T_{JMAX}$ 

<sup>3.</sup> Starting  $T_j = 25$  °C,  $I_D = 4A$ ,  $V_{DD} = 30V$ 

<sup>2.</sup> When Mounted on minimum recommended footprint

<sup>3.</sup> for 10 sec. 1.6 mm from case

Electrical characteristics STN3NF06

# 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0$				V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating, $V_{DS}$ = Max rating @ 125°C			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±20V			± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.5A		0.07	0.10	Ω

Table 4. Dynamic

Symbol	nbol Parameter Test conditions Min		Min.	Тур.	Max.	Unit
9 <sub>fs</sub> (1)	Forward transconductance	V <sub>DS</sub> = 15V, I <sub>D</sub> =1.5A		3		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Output capacitance $V_{DS} = 25V$ , f=1 MHz, $V_{GS} = 0$			315 70 30		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ =48V, $I_{D}$ = 3A $V_{GS}$ =10V (see Figure 14)		10 3.5 3.5	13	nC nC nC

<sup>1.</sup> Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on delay time rise time	$V_{DD}$ =30 V, $I_{D}$ =1.5A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =10V (see Figure 13)		7 18		ns ns
t <sub>d(off)</sub>	Turn-off delay time fall time	$V_{DD}$ =30 V, $I_{D}$ =1.5A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =10V (see Figure 13)		17 6		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current				4	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				16	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> =4A, V <sub>GS</sub> =0			1.3	٧
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ =4 A, di/dt = 100A/ $\mu$ s, $V_{DD}$ =25 V, Tj=150°C (see Figure 15)		50 88 3.5		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: pulse duration=300µs, duty cycle 1.5%

Electrical characteristics STN3NF06

## 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

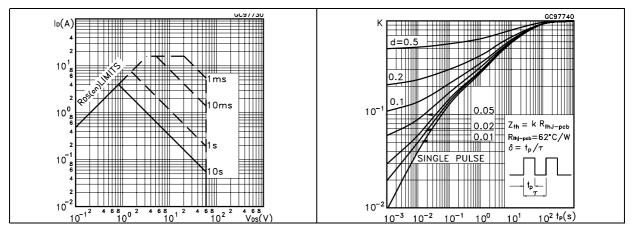


Figure 3. Output characteristics

Figure 4. Transfer characteristics

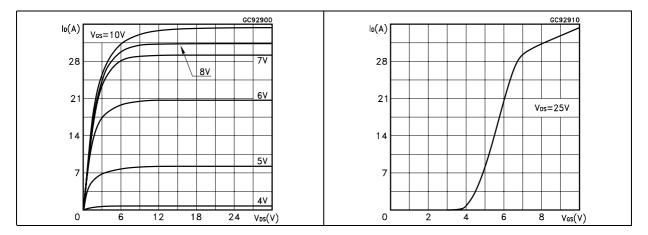
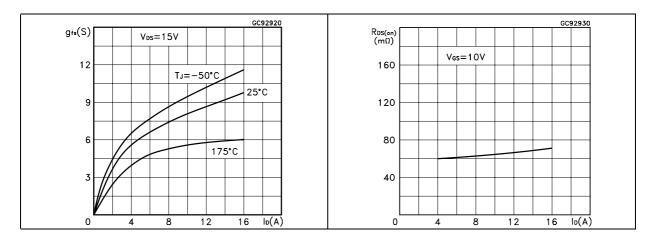


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



6/12

Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

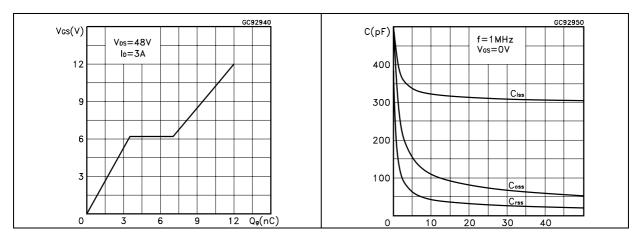


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs. vs. temperature temperature

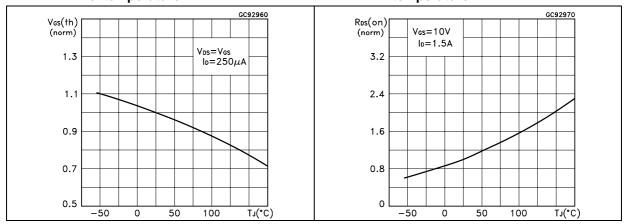
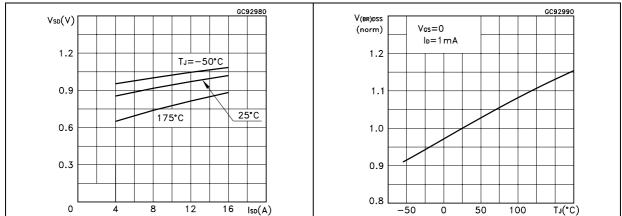


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized breakdown voltage vs. temperature



477

Test circuit STN3NF06

## 3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

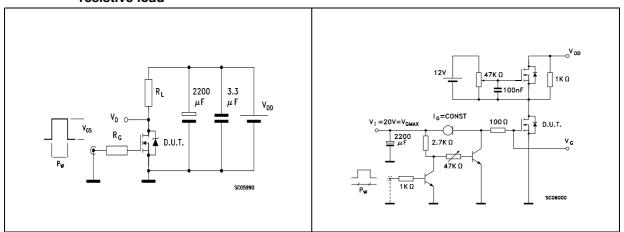


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

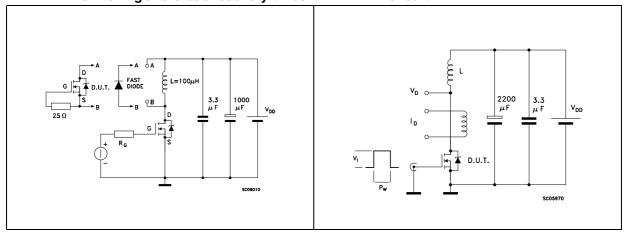
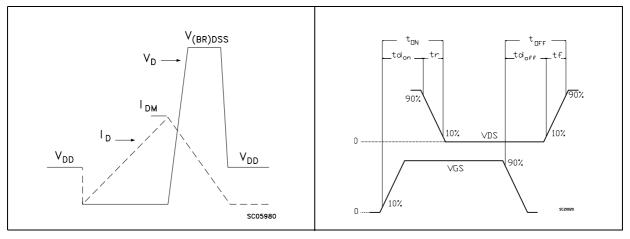


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



**577** 

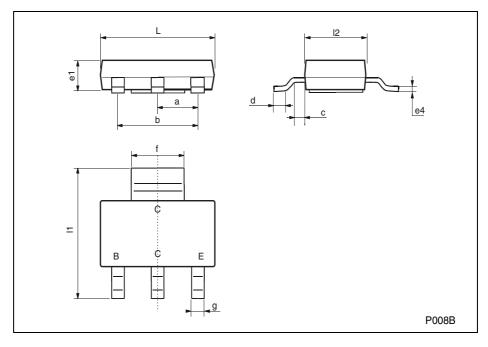
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

**47/** 

#### **SOT-223 MECHANICAL DATA**

DIM.		mm			mils	
Diw.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
а	2.27	2.3	2.33	89.4	90.6	91.7
b	4.57	4.6	4.63	179.9	181.1	182.3
С	0.2	0.4	0.6	7.9	15.7	23.6
d	0.63	0.65	0.67	24.8	25.6	26.4
e1	1.5	1.6	1.7	59.1	63	66.9
e4			0.32			12.6
f	2.9	3	3.1	114.2	118.1	122.1
g	0.67	0.7	0.73	26.4	27.6	28.7
l1	6.7	7	7.3	263.8	275.6	287.4
12	3.5	3.5	3.7	137.8	137.8	145.7
L	6.3	6.5	6.7	248	255.9	263.8



STN3NF06 Revision history

# 5 Revision history

Table 7. Revision history

Date	Revision	Changes
21-Jun-2004	4	Complete datasheet
04-Oct-2006	5	The document has been reformatted
01-Feb-2007	6	Typo mistake on <i>Table 1</i> .

11/12

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

477

# AMEYA360 Components Supply Platform

### **Authorized Distribution Brand:**

























#### Website:

Welcome to visit www.ameya360.com

#### Contact Us:

#### Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

#### > Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

#### Customer Service :

Email service@ameya360.com

## Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com